July 2008



FDW2521C

Complementary PowerTrench[®] MOSFET

General Description

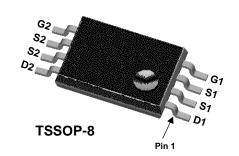
This complementary MOSFET device is produced using Fairchild's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

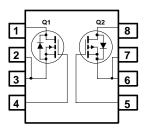
Applications

- DC/DC conversion
- Power management
- Load switch

Features

- Q2: P-Channel -3.8 A, 20 V. $R_{DS(ON)} = 43 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 70 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- High performance trench technology for extremely low R_{DS(ON)}
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol		Parameter		Q1	Q2	Units
V _{DSS}	Drain-Sourc	e Voltage		20	-20	V
V _{GSS}	Gate-Source	e Voltage		±12	±12	V
I _D	Drain Curre	nt - Continuous	(Note 1a)	5.5	-3.8	A
		- Pulsed		30	-30	
PD	Power Dissipation		(Note 1a)	1.0		W
			(Note 1b)	0.6		
T _J , T _{STG}	Operating a	Operating and Storage Junction Temperature Range		-55 to	+150	°C
	I Charac		ent (Note 1a)	12	25	°C/₩
		teristics sistance, Junction-to-Ambi	ent (Note 1a) (Note 1b)		25	°C/W
R _{θJA}	Thermal Re		(Note 1b)			°C/W
R _{eja} Packag	Thermal Re	sistance, Junction-to-Ambi	(Note 1b)		08	C/W

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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Char	acteristics						
BV _{DSS}	Drain-Source Breakdown	V _{GS} = 0 V, I _D = 250 μA	Q1	20			V
	Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	Q2	-20			
	Breakdown Voltage	$I_D = 250 \ \mu$ A, Referenced to 25° C	Q1		14		mV/°0
ΔT_J	Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25° C	Q2		-16		<u> </u>
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$	Q1 Q2			1 _1	μA
I _{GSS}	Gate-Body Leakage	$V_{\text{DS}} = -10$ V, $V_{\text{GS}} = 0$ V $V_{\text{GS}} = \pm 12$ V, $V_{\text{DS}} = 0$ V	Q2 Q1			+100	nA
IGSS	Cale-Dody Leakage	$V_{GS} = \pm 12$ V, $V_{DS} = 0$ V $V_{GS} = \pm 12$ V, $V_{DS} = 0$ V	Q2			<u>+</u> 100 +100	
On Char	acteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	Q1	0.6	0.8	1.5	V
00(11)	6	$V_{DS} = V_{GS}, I_D = -250 \mu A$	Q2	-0.6	-1.0	-1.5	
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$	Q1		-3.2		mV/°0
ΔT_{J}	Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25° C	Q2		3.0		
	Static Drain-Source	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$	Q1		17	21	mΩ
	On-Resistance	$V_{GS} = 2.5 \text{ V}, I_D = 4.2 \text{ A}$			24	35	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$	00		23	34 43	-
		$V_{GS} = -4.5 \text{ V}, I_D = -3.8 \text{ A}$ $V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$	Q2		36 56	43 70	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_D = -3.8 \text{ A}, \text{ T}_J = 125^{\circ}\text{C}$			49	69	
D(on)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	Q1	30	-		Α
- ()		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	Q2	-15			
GFS	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$	Q1		26		S
		$V_{DS} = -5 V, I_D = -3.5 A$	Q2		13.2		
	Characteristics					1	
Ciss	Input Capacitance	Q1: V _{DS} = 10 V, V _{GS} = 0 V,	Q1 Q2		1082 1030		pF
Coss	Output Capacitance	$v_{DS} = 10 v, v_{GS} = 0 v,$ f = 1.0 MHz	Q2 Q1		277		pF
Ooss	Ouipui Capacitance	Q2:	Q2		280		p
Crss	Reverse Transfer	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$	Q1		130		pF
- 100	Capacitance	f = 1.0 MHz	Q2		120		
Switching	g Characteristics						
d(on)	Turn-On Delay Time	Q1:	Q1		8	20	ns
		$V_{DD} = 10 V, I_D = 1 A,$	Q2		11	20	
tr	Turn-On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	Q1		8	27	ns
•	Turn-Off Delay Time	Q2: V _{DD} = -5 V, I _D = -1 A,	Q2 Q1		18 24	32 38	
t _{d(off)}	Turn-On Delay Time	$V_{\text{DD}} = -3$ V, $V_{\text{D}} = -1$ A, $V_{\text{GS}} = -4.5$ V, $R_{\text{GEN}} = 6 \Omega$	Q2		24 34	55	ns
t _f	Turn-Off Fall Time		Q1		8	16	ns
			Q2		34	55	
J ^a	Total Gate Charge	Q1:	Q1		12	17	nC
		$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}, \text{ V}_{GS} = 4.5 \text{ V}$	Q2		9.7	16	<u> </u>
\mathbf{Q}_{gs}	Gate-Source Charge	Q2:	Q1		2		nC
<u></u>	Cata Drain Charge	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -3.8 \text{ A}, \text{V}_{GS} = -4.5 \text{ V}$	Q2		2.2		
\mathbf{Q}_{gd}	Gate-Drain Charge	$v_{DS} = 0 v, v_D = -0.0 \Lambda, v_{GS} = -4.0 V$	Q1 Q2		3 2.4		nC
			942		2.4		

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
	una Dia da Okana stanist	las and Marinerus Dathers					
Drain-So	urce Diode Characterist	ics and Maximum Ratings					
1	urce Diode Characterist Maximum Continuous Drain-S	U	Q1			0.83	A
Drain-So Is		U	Q1 Q2			0.83 0.83	A
		U			0.7		A

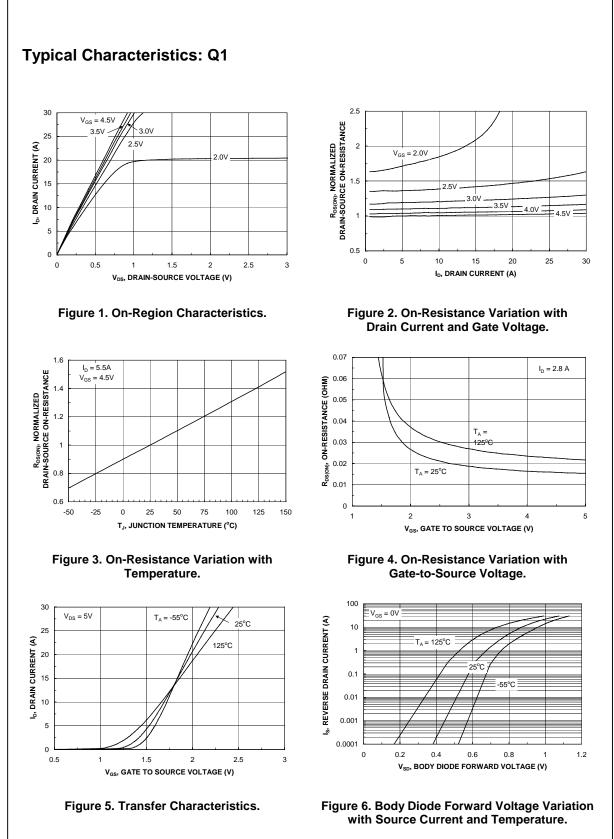
Notes:

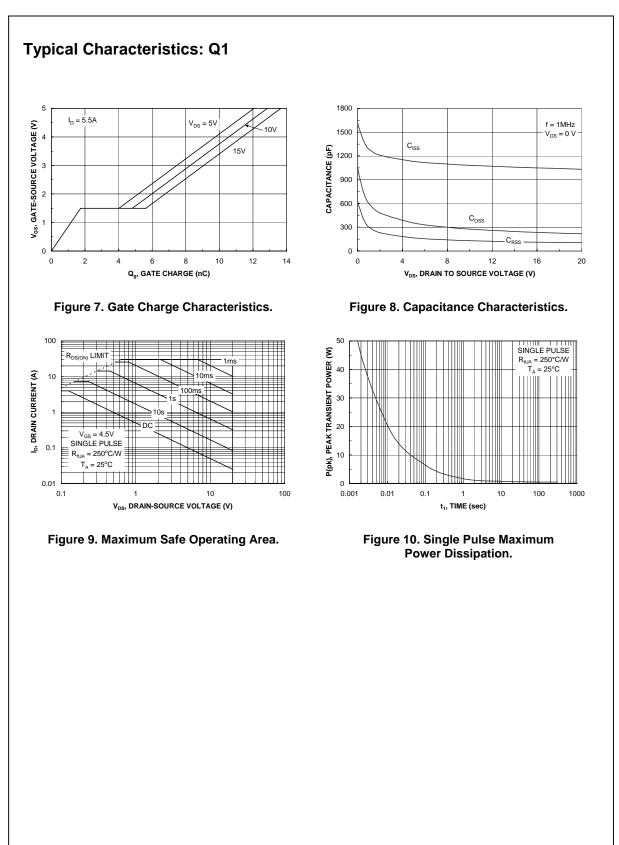
 R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.

a) $\,R^{}_{_{\theta JA}}\,is\,125^\circ C/W$ (steady state) when mounted on a 1 inch² copper pad on FR-4.

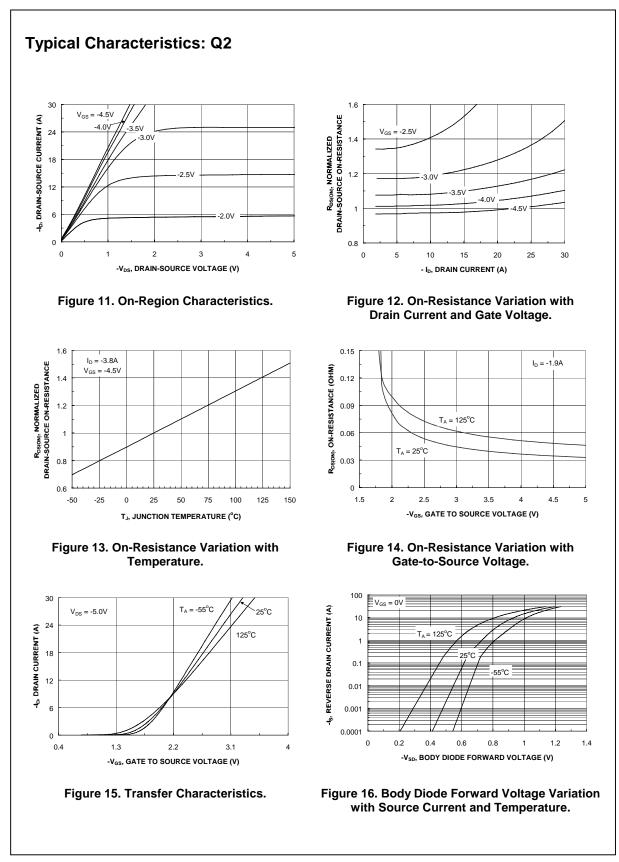
b) $R_{\theta JA}$ is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

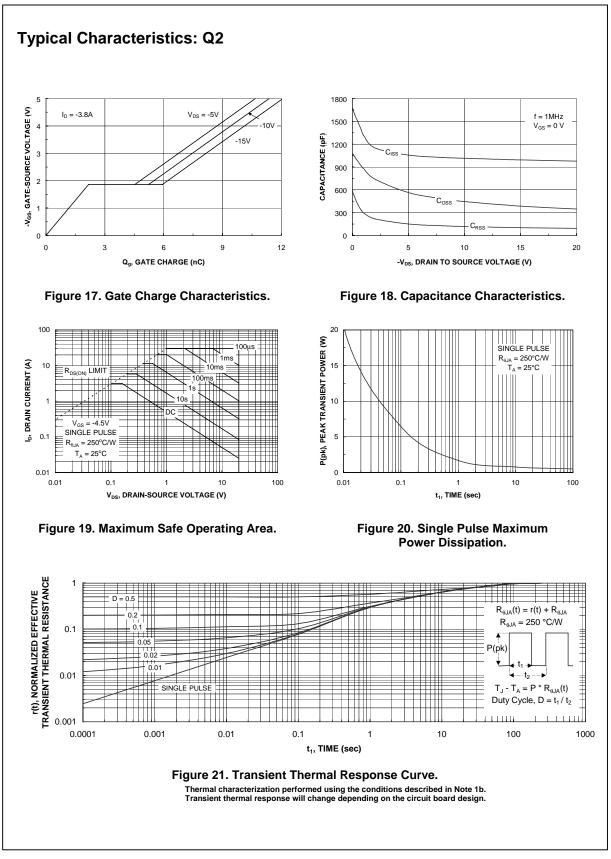
2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%











FDW2521C Rev D1(W)



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